**Proposal for licensing**

Date　(　 　/　 /　　　)

|  |  |
| --- | --- |
| Name |  |
| Company/ Organization name |  |
| E-mail address |  |

|  |  |
| --- | --- |
| Product name |  |
| Expected indication |  |
| Brief summery | Please fill in the product information such as the characteristics, mechanism of action, development status. |
| Relevant patents |  |
| Desired contract type |  |
| Notices |  |

1. Nippon Shinyaku will not treat the information that you give us as confidential or proprietary, and thus will not be restricted from using such information or disclosing such information to third parties.
2. Nippon Shinyaku will treat personal information such as name, address, and telephone number according to Nippon Shinyaku’s privacy policy.
3. Submitting this application does not guarantee an opportunity to collaborate with us. The decision to proceed with a collaboration will be taken by Nippon Shinyaku alone.